SMD Power Choke Coil

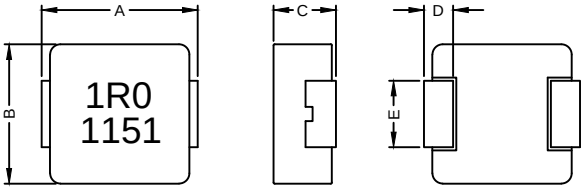
PIC0602H SERIES

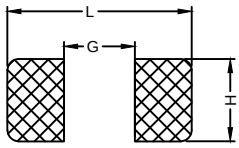
1. PART NO. EXPRESSION :

P I C 0 6 0 2 H 1 R 0 M F - □□
(a) (b) (c) (d) (e)(f) (g)

(a) Series code
(b) Dimension code
(c) Type code
(d) Inductance code : 1R0 = 1.0uH
(e) Tolerance code : M = ±20%, Y = ±30%
(f) F : RoHS Compliant
(g) 11~99 : Internal controlled number

2. CONFIGURATION & DIMENSIONS :



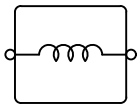


Recommended PC Board Pattern

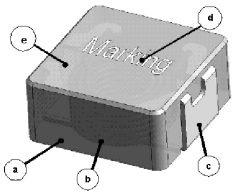
Unit:m/m

A	B	C	D	E	G	H	L
7.0±0.3	6.6±0.3	1.8±0.2	1.8±0.3	3.0±0.3	2.5	3.5	7.7

3. SCHEMATIC :



4. MATERIALS :



(a) Core
(b) Wire
(c) Terminal
(d) Ink
(e) Paint

RoHS Compliant

NOTE : Specifications subject to change without notice. Please check our website for latest information.

06.11.2015

5. GENERAL SPECIFICATION :

a) Test Freq. : L : 100KHz/1.0V

b) Operating Temp. : -40°C to +125°C

c) Storage Temp. : -40°C to +125°C

d) Humidity Range : 85 ± 3% RH

e) Heat Rated Current (Irms) will cause the coil temperature rise approximately Δt of 40°C (keep 1min)

f) Saturation Current (Isat) will cause L0 to drop 20%.

g) Part Temperature (Ambient+Temp. Rise) : Should not exceed 125°C under worst case operating conditions.

h) Storage condition (component in its packaging)

i) Temperature: -10 to 40°C

ii) Humidity : 50~60% RH

6. ELECTRICAL CHARACTERISTICS :

Part No.	Inductance L_0 (μH) @ 0 A	Irms (A) Typ.	Isat (A) Typ.	DCR (mΩ) Typ. @ 25°C	DCR (mΩ) Max. @ 25°C
PIC0602HR10YF	0.10	21	40	2.0	2.4
PIC0602HR16YF	0.16	18	38	2.3	2.7
PIC0602HR20YF	0.20	18	35	2.5	3.0
PIC0602HR33MF	0.33	14	25	4.5	5.0
PIC0602HR47MF	0.47	11.7	20	7.1	8.3
PIC0602HR56MF	0.56	11	18	7.9	9.3
PIC0602HR68MF	0.68	10.5	16	8.3	10
PIC0602H1R0MF	1.00	8.0	14	16.5	18
PIC0602H1R5MF	1.50	7	12	23	27
PIC0602H2R2MF	2.20	6.0	10	32	37
PIC0602H3R3MF	3.30	5.0	8.0	43	48
PIC0602H4R7MF	4.70	4.5	7.0	53	60
PIC0602H5R6MF	5.60	4.0	6.0	59	68
PIC0602H6R8MF	6.80	4.0	5.5	63	73
PIC0602H8R2MF	8.20	3.2	5.0	101	116
PIC0602H100MF	10.0	2.8	4.0	134	154
PIC0602H150MF	15.0	2.1	3.3	190	210
PIC0602H220MF	22.0	1.5	2.5	236	280

Tolerance : M = ±20%,Y = ±30%

RoHS Compliant

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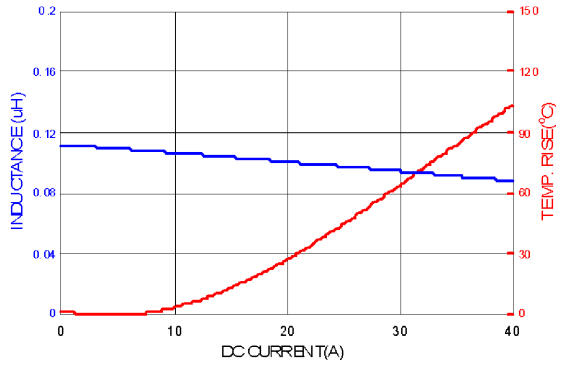
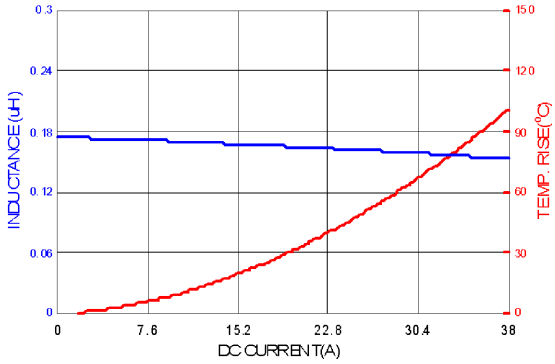
7. CHARACTERISTICS CURVES :

PIC0602HR10YF



PIC0602HR16YF



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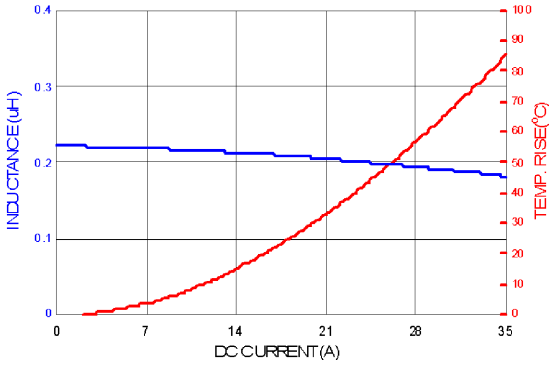

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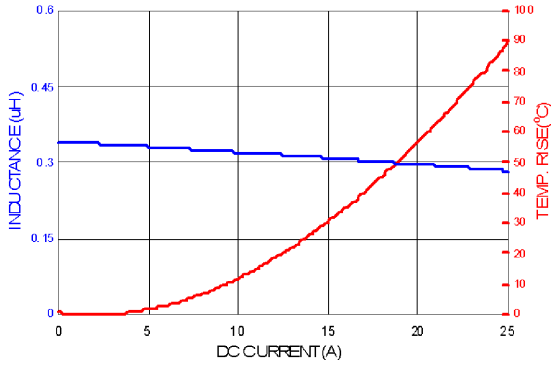

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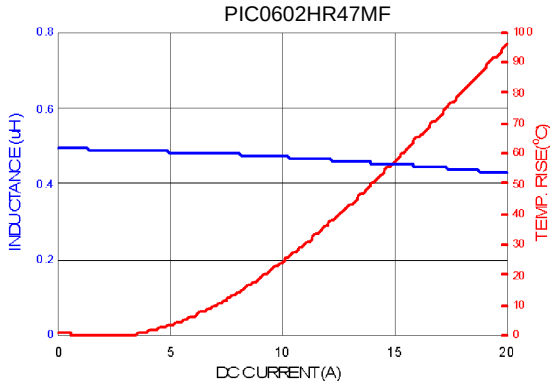

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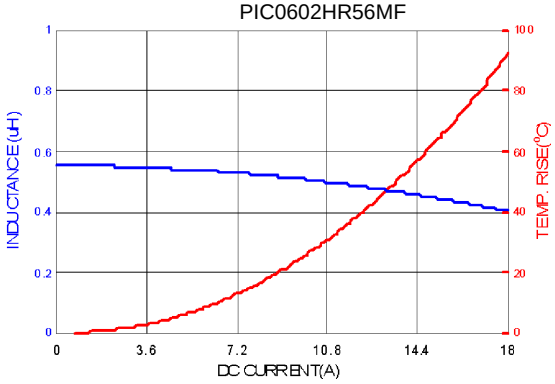

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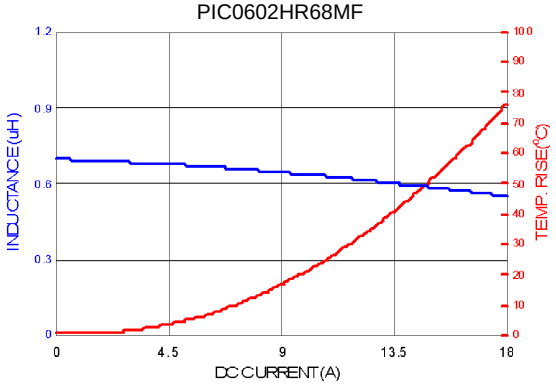
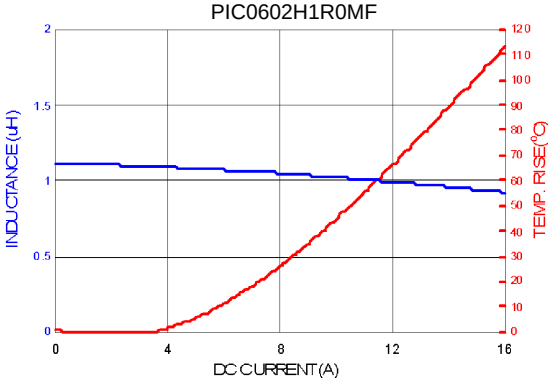
7. CHARACTERISTICS CURVES :

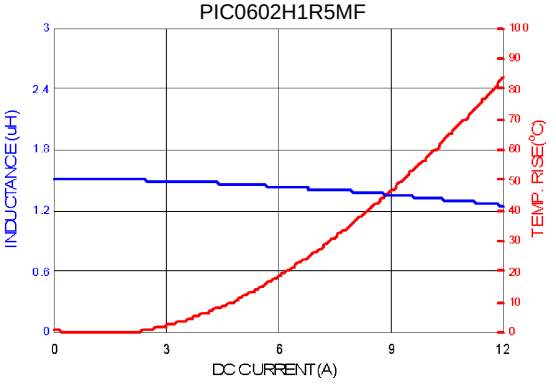
PIC0602HR68MF



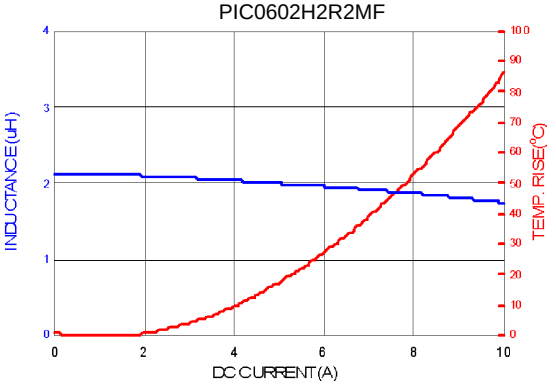
PIC0602H1R0MF



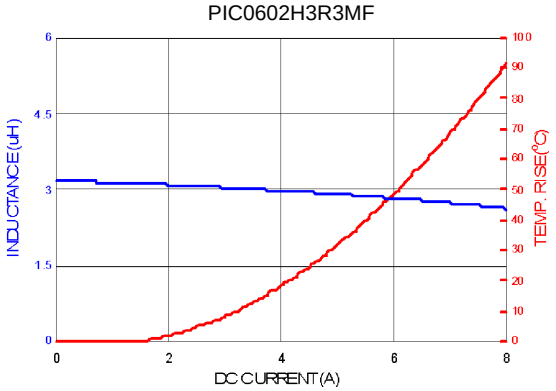
PIC0602H1R5MF



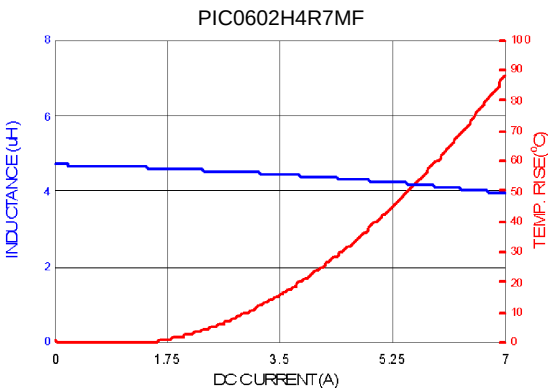
PIC0602H2R2MF



PIC0602H3R3MF



PIC0602H4R7MF



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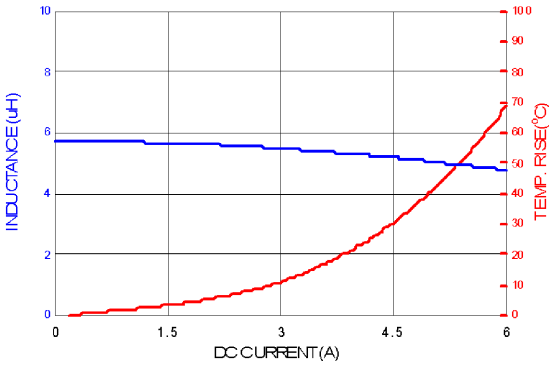
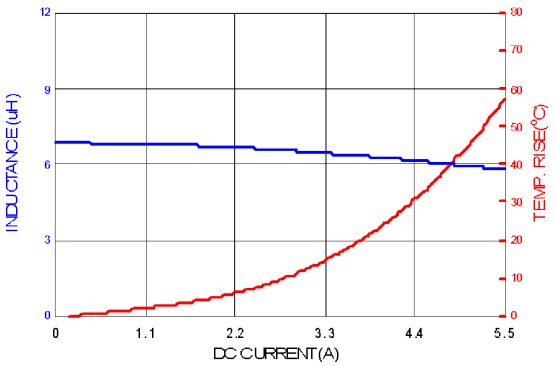
7. CHARACTERISTICS CURVES :

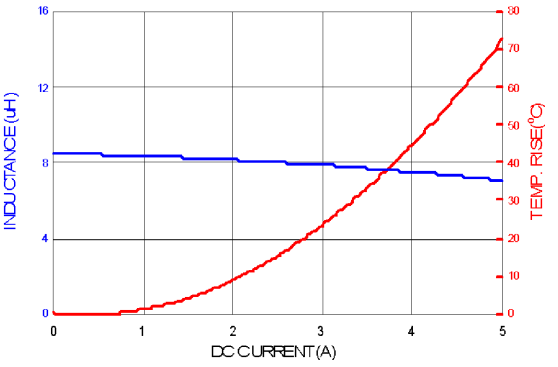
PIC0602H5R6MF



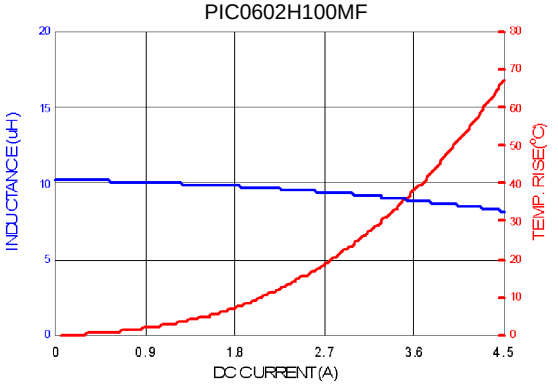
PIC0602H6R8MF



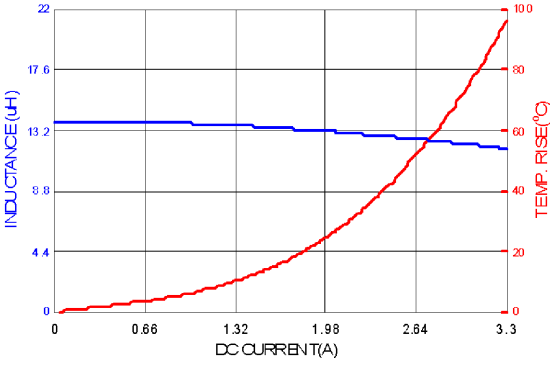
PIC0602H8R2MF



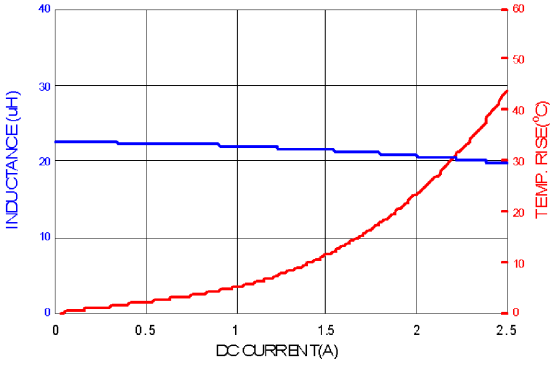
PIC0602H100MF



PIC0602H150MF



PIC0602H220MF



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8. SOLDERING :

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1.1 Solder Re-flow :

Recommended temperature profiles for re-flow soldering in Figure 1.

8-1.2 Soldering Iron (Figure 2) :

Products attachment with soldering iron is discouraged due to the inherent process control limitations.
In the event that a soldering iron must be employed the following precautions are recommended.
Note :

a) Preheat circuit and products to 150°C.
b) 355°C tip temperature (max)
c) Never contact the ceramic with the iron tip
d) 1.0mm tip diameter (max)
e) Use a 20 watt soldering iron with tip diameter of 1.0mm
f) Limit soldering time to 4~5 secs.

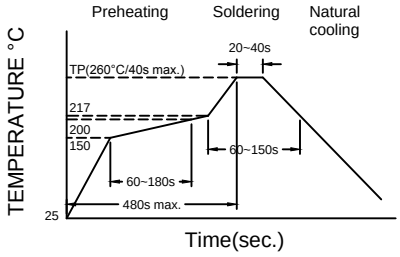

Figure 1. Re-flow Soldering: 3 times max.

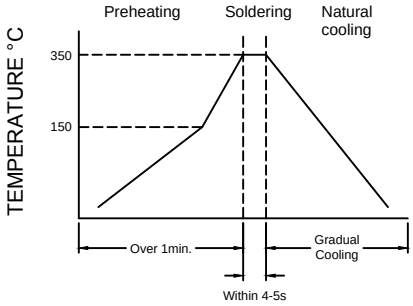

Figure 2. Hand Soldering: 1 times max.

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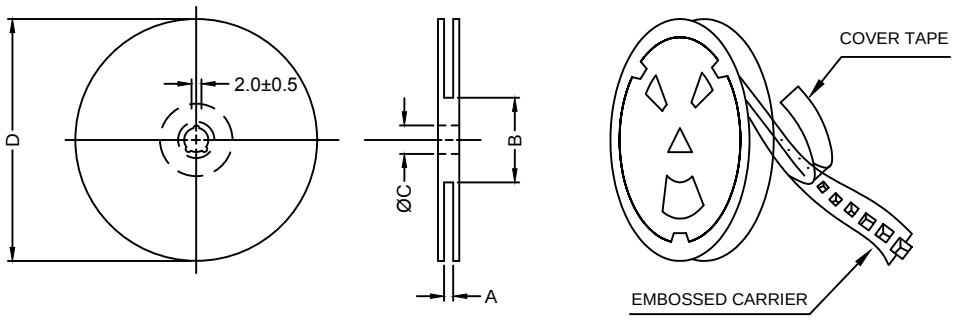
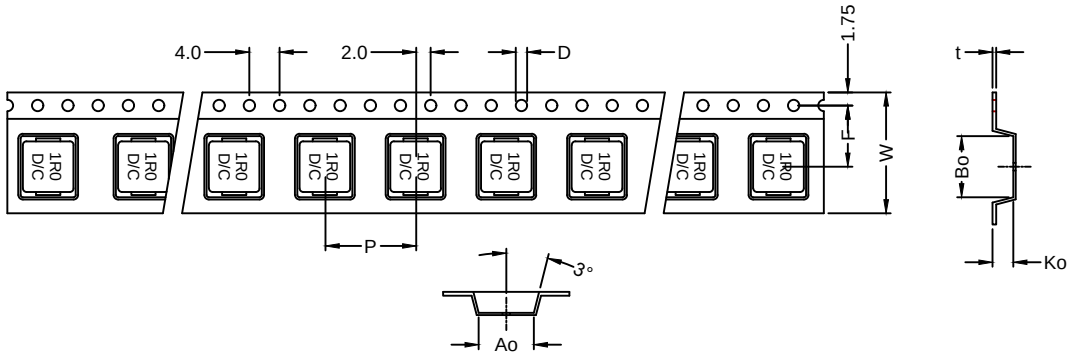
9. PACKAGING INFORMATION :

9-1. Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
13" x 16mm	16.4+2.0/-0	100±2.0	13.5±0.5	330

9-2. Tape Dimension



Series	Ao(mm)	Bo(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)	D(mm)
PIC0602	7.0±0.1	7.7±0.1	2.3±0.1	12.0±0.1	16.0±0.3	7.5±0.1	0.35±0.05	1.5±0.1

9-3. Packaging Quantity

Size	PIC0602
Chip / Reel	1500
Inner Box	3000
Carton	12000

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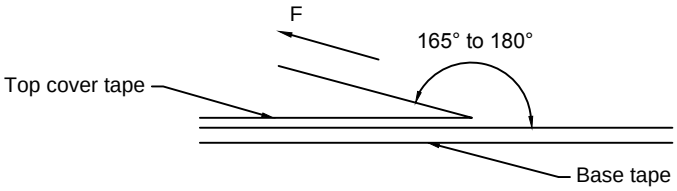
9-4. Tearing Off Force



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions. (referenced ANSI/EIA-481-C-2003 of 4.11 standard)

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed (mm/min)
5~35	45~85	860~1060	300

Application Notice

1. Storage Conditions :
   To maintain the solderabililty of terminal electrodes :
   a) Recommended products should be used within 12 months from the time of delivery.
   b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation :
   a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
   b) Vacuum pick up is strongly recommended for individual components.
   c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

RoHS Compliant

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